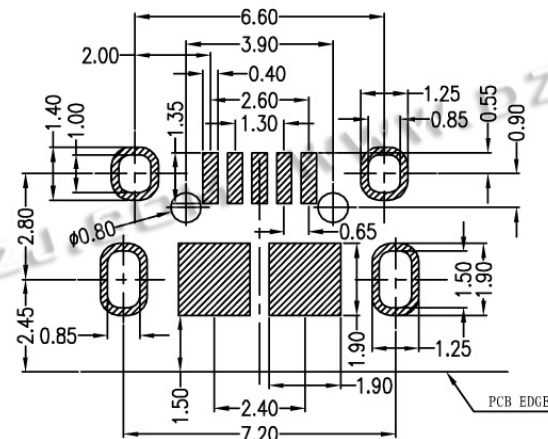
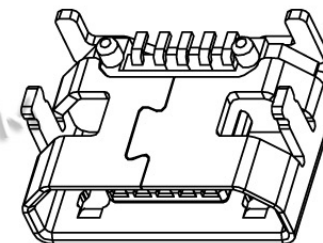
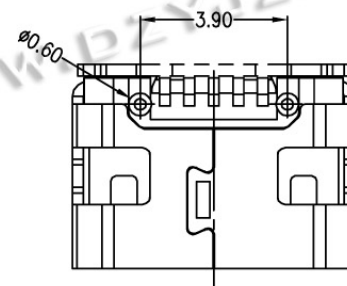
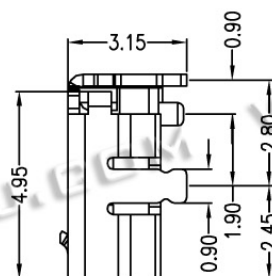
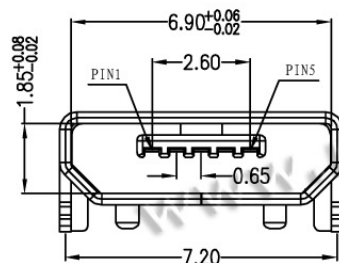
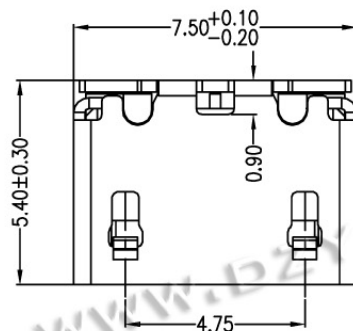
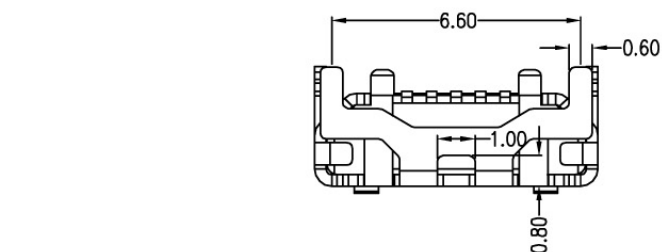




RECOMMEND PCB LAYOUT
PCB图仅供参考

Note:

1.Material:

1.1 Housing: LCP High temperature thermoplastic with g.f,UL94v-0

1.2 Contact: copper alloy, $t=0.15\text{mm}$

1.3 Shell: SUS304, $t=0.30\text{mm}$

2.Specification:

2.1 Current rating: 1 A Max.

2.2 Dielectric withstanding

voltage: 100 V(ac) for 1 min.

2.3 Contact resistance: 30 M Ω Max.

2.4 Insulation resistance: 100 M Ω Min.

2.5 Total mating force: 3.57 Kg Max.

2.6 Total unmating force: 1.0 Kg Min.

2.7 Temperature range: $-30^{\circ}\text{C}\sim 80^{\circ}\text{C}$



深圳市华宇创精密电子有限公司

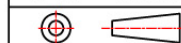
TOLERANCE:

X.X ± 0.30

X.XX ± 0.25

X.XXX ± 0.15

X' $\pm 2'$ X.X' $\pm 0.5'$



UNIT: mm [inch]

SCALE: 1:1 SIZE: A4

DRAWN BY :

陈一鸣

DATE :

2014-02-23

PART NAME:

MICRO USB 5P B型大牛角7.2-6.6短针 无卷边

CHECKED BY:

马跃

DATE :

2014-02-23

PART NO.

HYC116-USBD05-720

APPROVED BY:

邱国夷

DATE :

2014-02-23

DRAW NO:

HYC-USBI6082910

SHEET NO.

1 OF 1